



DDZX5V6AQ - DDZX12CQ

SURFACE-MOUNT PRECISION ZENER DIODE

Features

- 300mW Power Dissipation on FR-4 PCB
- Very Tight Tolerance on Vz
- Ideally Suited for Automated Assembly Processes
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DDZX5V6AQ DDZX12CQ are suitable for automotive applications requiring specific change control; these parts are AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

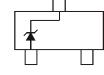
Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)

SOT23



Top View



Device Schematic

Ordering Information (Note 4)

Derf Number	Deekono	Pack	ing
Part Number	Package	Qty.	Carrier
DDZX5V6AQ-7	SOT23	3000	Tape & Reel
DDZX12CQ-7	SOT23	3000	Tape & Reel

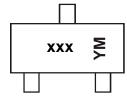
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

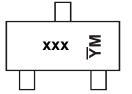
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\begin{array}{l} xxx = \mbox{Product Type Marking Code} \\ (See Electrical Characteristics Table) \\ YM = \mbox{Date Code Marking for Shanghai} \\ Assembly/Test Site \\ Y = Year (ex: L = 2024) \\ M = Month (ex: 3 = March) \end{array}$



xxx = Product Type Marking Code (See *Electrical Characteristics* Table) $\overline{Y}M$ = Date Code Marking for Chengdu Assembly/Test Site \overline{Y} = Year (ex: L = 2024) M = Month (ex: 3 = March)

Date Code Key

Notes:

Year	2020	-	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	Н	-	L	М	Ν	Р	R	S	Т	U	V	W
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Forward Voltage	@ I _F = 10mA	VF	0.9	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	300	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	Reja	417	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

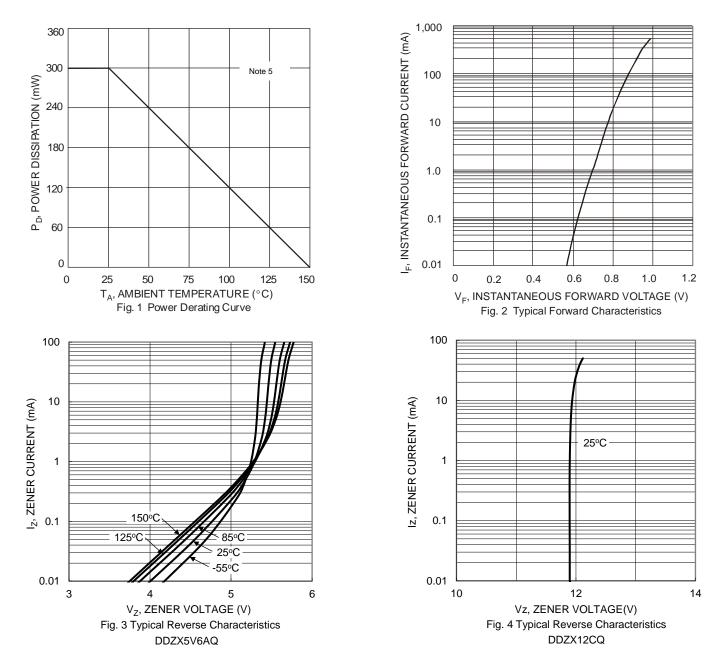
Don't Number	Marking	Zener Voltage Ran (Note 6)		nge	Ma	aximum Zene f = 1I		e		m Reverse t (Note 7)
Part Number	Code	Vz @	⊉ I _{ZT}	IZT	IZT	Z _{ZT} @ I _{ZT}	Z zк @ Izк	Izĸ	IR	@ V _R
		Min (V)	Max (V)	mA	mA	2	2	mA	μA	V
DDZX5V6AQ-7	KZ2	5.28	5.55	20	20	80	460	1	7.0	2.0
DDZASVOAQ-7	NZZ	5.15	5.45	5	20	80	400	Ι	7.0	2.0
DDZX12CQ-7	KYV	11.74	12.35	10	10	12	110	0.5	0.1	9.1

Notes:

Device mounted on FR-4 PCB with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
The zener voltage is measured < 40ms after power is supplied.
Short duration pulse test used to minimize self-heating effect.



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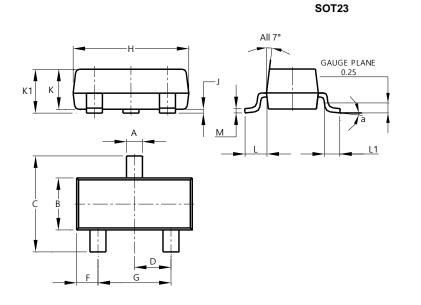


Note: 5. Device mounted on FR-4 PCB with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.



Package Outline Dimensions

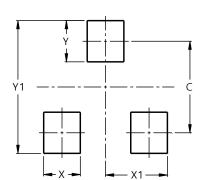
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
К	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All	Dimens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

DDZX5V6AQ - DDZX12CQ Document number: DS43120 Rev. 4 - 2



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